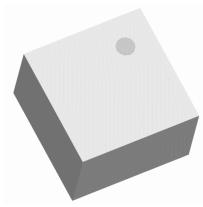




# Ultra Low Profile 0404 Balun $50\Omega$ to $50\Omega$ Balanced



## **Description:**

The BD3238N5050AHF is a low profile, low impedance subminiature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipset applications in an easy to use surface mount package. The BD3238N5050AHF is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. The BD3238N5050AHF has an unbalanced port impedance of  $50\Omega$  and a  $50\Omega$  balanced port impedance. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3238N5050AHF is available on tape and reel for pick and place high volume manufacturing.

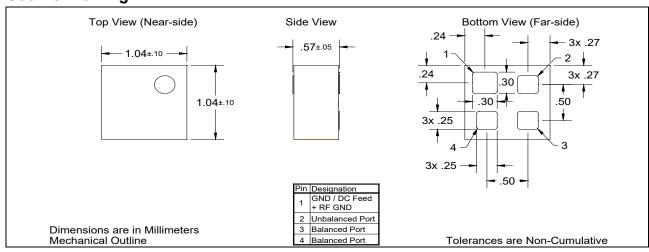
## **Detailed Electrical Specifications:**

Specifications subject to change without notice.

٠,	compations subject to on	ago	ROOM (25°C)									
	Features:	Parameter	Min.	Тур.	Max	Min.	Тур.	Max	Min.	Тур.	Max	Unit
•	3200 – 4200 MHz	Frequency	3200		3800	3400		3600			4200	MHz
•	0.57 mm Height Profile	Unbalanced Port Impedance		50			50			50		Ω
•	250hm	Balanced Port Impedance		50			50			50		Ω
•	Low Insertion Loss	Return Loss	7	11		8	12		10	13		dB
•	Surface Mountable	Insertion Loss*		0.9	1		0.7	1		0.7	1	dB
•	Tape & Reel Non-conductive	Amplitude Balance		0.6	1.5		0.4	1.5		0.2	0.7	dB
	Top Surface	Phase Balance		3	6		3	6		2	5	Degrees
•	RoHS Compliant	CMRR		28			30			34		dB
•	Halogen free	Power Handling @85C			1.0			1.0			1.0	Watts
		Operating Temperature	-55		+105	-55		+105	-55		+105	°C

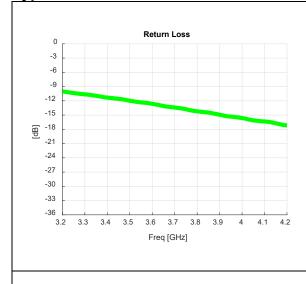
<sup>\*</sup> Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

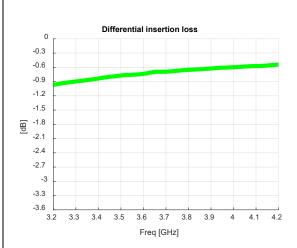
#### **Outline Drawing:**

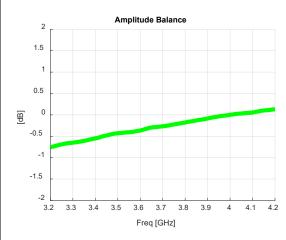


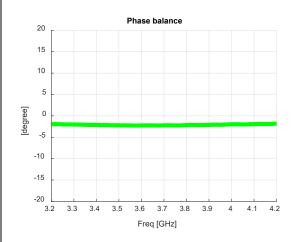


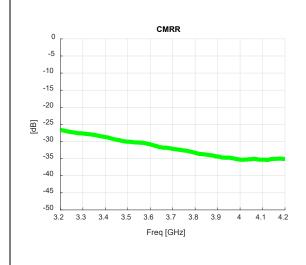
Typical Performance: 3200 MHz to 4200 MHz





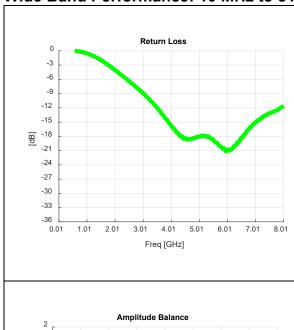


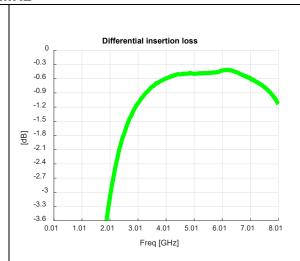


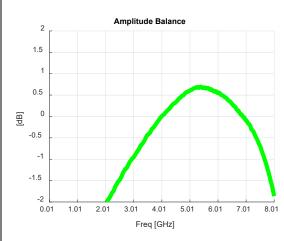


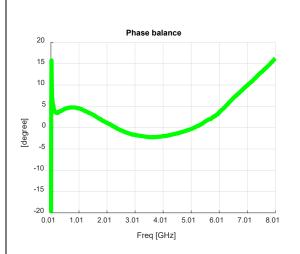


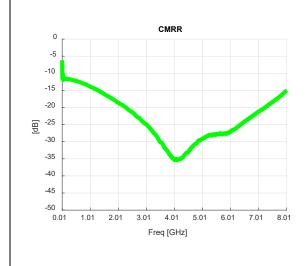
## Wide Band Performance: 10 MHz to 8100 MHz











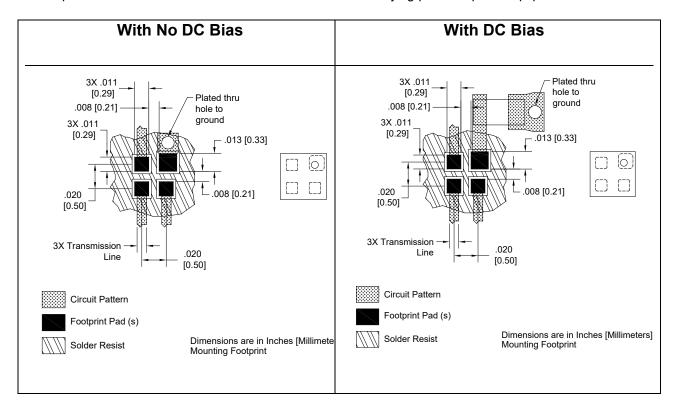


### **Mounting Configuration:**

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability.

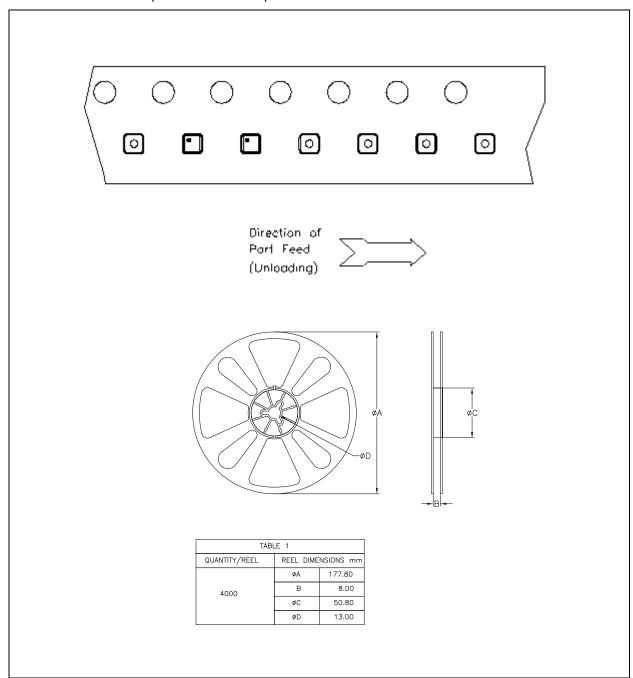
An example of the PCB footprint used in the testing of these parts is shown below. An example of a DC-biased footprint is also shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.





## **Packaging and Ordering Information:**

Parts are available in reel and are packaged per EIA 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.



#### Contact us:

rf&s\_support@ttm.com

